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Sunday, September 10, 2006

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Product Details for MICROSMD010F-2



MICROSMD010F-2

Tyco Part Number: A65230-000



PolySwitch Resettable Devices



Product Highlights:

- Surface Mount Application
- Family Name = microSMD
- Surface Mount Construction
- IH (Room Temperature) = .1 Amps.
- IT (Room Temperature) = .25 Amps.

View all Features

Product Features (Please use the Product Drawing for all design activity)

Quick Links

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Documentation & Additional Information

Product Drawings:

• microSMD010F (PDF, English)

Catalog Pages/Data Sheets:

None Available

Product Specifications:

None Available

Application Specifications:

None Available

Instruction Sheets:

• None Available

CAD Files:

None Available

Additional Information:

Product Line Information

Related Products:

Tooling

List all Documents

Product Type Features:

• UL Recognized = 070501-E74889

Electrical Characteristics:

- IH (Room Temperature) (Amps.) = 0.1
- IT (Room Temperature) (Amps.) = 0.25
- Vmax Operating (V) = 30
- Rmin() = 2.10
- R1 Max [Post Trip] () = 15.00
- <u>UL Rated Current (Amps.)</u> = 10
- Tripped Power Dissipation (Typical) (W) = 0.80

Termination Related Features:

• Construction = Surface Mount

Body Related Features:

• CSA File No. = 1031175 (CA 78165-1)

Contact Related Features:

• <u>Family Name</u> = microSMD

Configuration Related Features:

- Form Factor (inches) = 1210
- Form Factor (mm) = 3225

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Reflow solder capable to 245°
 C, Reflow solder capable to 260°C
- RoHS/ELV Compliance History = Always was RoHS compliant
- TUV Certificate No. = R72041438

Conditions for Usage:

• Operating Temperature (Max.) (°C) = 85

Operation/Application:

• Application = Surface Mount

Packaging Related Features:

Packaging Method = Tape & Reel

Other:

• Brand = Raychem

Languages: English | Deutsch | Español | Português (do Brasil) | ______ | Italiano | 正體中文 (繁體) | 中文 (简体) | 日本語

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